



## Material Content Data Sheet



<b>Sales Product Name</b>		TLE6251-3G		<b>Issued</b>		1. August 2018		
<b>MA#</b>		MA000977742						
<b>Package</b>		PG-DSO-14-1		<b>Weight*</b>		143.59 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	5.050	3.52	3.52	35168	35168
leadframe	inorganic material	phosphorus	7723-14-0	0.015	0.01		105	
	non noble metal	zinc	7440-66-6	0.060	0.04		420	
	non noble metal	iron	7439-89-6	1.207	0.84		8405	
wire	non noble metal	copper	7440-50-8	49.007	34.13	35.02	341293	350223
	noble metal	gold	7440-57-5	0.196	0.14	0.14	1367	1367
	encapsulation	organic material	carbon black	1333-86-4	0.168	0.12		1168
plastics		epoxy resin	-	7.717	5.37		53745	
		inorganic material	silicondioxide	60676-86-0	76.000	52.93	58.42	529276
leadfinish	non noble metal	tin	7440-31-5	1.226	0.85	0.85	8539	8539
plating	noble metal	silver	7440-22-4	1.030	0.72	0.72	7172	7172
glue	plastics	acrylic resin	-	0.421	0.29		2935	
	noble metal	silver	7440-22-4	1.494	1.04	1.33	10407	13342
*deviation	< 10%					Sum in total:	100.00	1000000

### Important Remarks:

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Company	Infineon Technologies AG
Address	81726 München
Internet	www.infineon.com